

Bluetooth Low Energy Module (BT5.0)



Key Features

- Bluetooth 4 and 5 low energy
- Powerful ARM Cortex-M4F processor
 - Clock speed: up to 48MHz
 - 352KB of In-System programmable flash with 8KB cache
 - 80KB SRAM
 - 8KB of cache SRAM
 - 2-Pin cJTAG and JTAG debugging
 - Support Over-the-Air upgrade (OTA)
 - Ultra-Low power sensor controller with 4KB of SRAM
 - 31 GPIOs
 - 4 x 32-Bit or 8 x 16-Bit general purpose timer
 - 12-Bit ADC, 200 kSamples/s, 8 channels
 - 2 x comparator with internal reference DAC
 - Programmable current source
 - 2 x UART
 - 2 x SSI (SPI, MICROWIRE, TI)
 - IIC, IIS
 - Real-Time-Clock (RTC)
 - AES 128- and 256-bit crypto accelerator
 - ECC and RSA public key hardware accelerator
 - SHA2 accelerator (Full suite up to SHA-512)
 - True Random Number Generator (TRNG)
 - Capacitive sensing, up to 8 channels
 - Integrated temperature and battery monitor
 - On-Chip buck DC/DC converter
- RF performance
 - TX power: -21dBm to 5dBm
 - RX sensitivity: up to -105dBm (LE coded PHY)
- Communication range: about 250 meters (LOS) – Long Range Mode
- Antenna: PCB antenna, 1.17 dBi gain
- Size: 22.95 mm x 15 mm x 2.1 mm (With Shielding)
- Ultra low power consumption:

- Shutdown: 120nA (Wake up on external events)
- Standby: 0.95uA (RTC running and RAM/CPU retention)
- RX current: 6.9mA
- TX current @ 0dBm: 7.4mA
- TX current @ 5dBm: 9.7mA
- Industrial grade operating temperature range from -40°C to +105°C
- Pin to pin compatible with BDE-BLEM205
- BQB, FCC, CE, RoHS compliant

Descriptions

BDE-BLEM205-IN is a Bluetooth 4 and 5 single-mode compliant Bluetooth low energy module targeted at low power sensors and PC/Phone accessories.

BDE-BLEM205-IN highly integrates Bluetooth Low Energy radio, stack, profile and applications in a SoC, without the need of using an external MCU. The module also offers flexible hardware interfaces for the sensor application.

It enables ultra-low power connectivity and data transfer for the applications that are sensitive to power consumption, size and cost.

Block Diagram

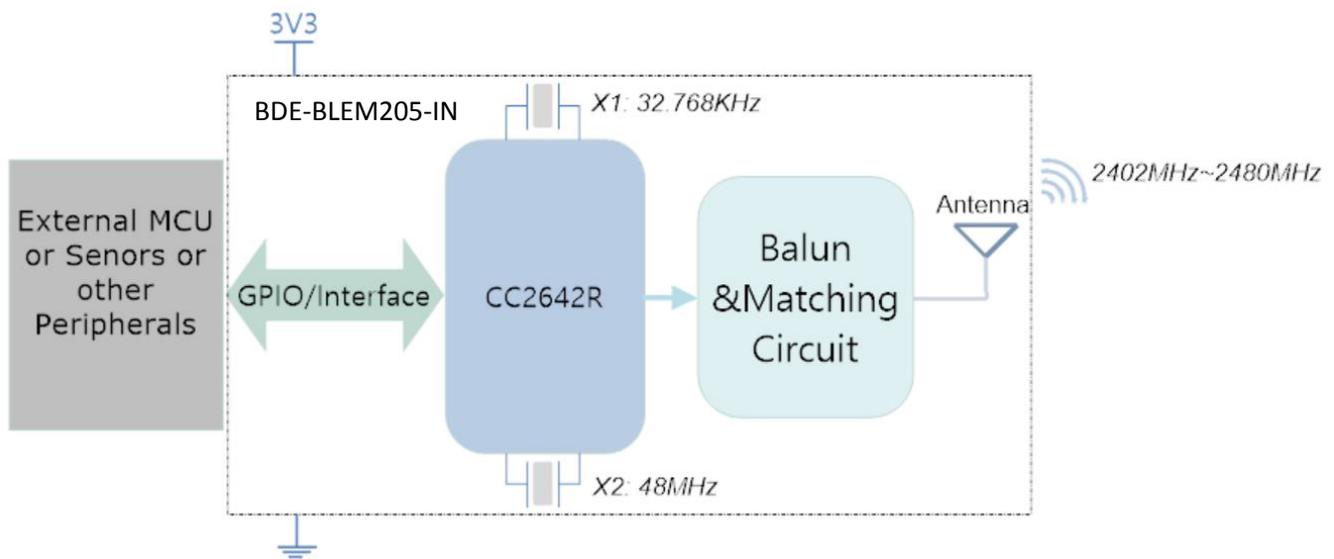


Fig. 1: The Block Diagram of BDE-BLEM205-IN

Applications

- Medical devices
- Sports and fitness equipment
- Home electronics
- Mobile and PC accessories
- Industry automation

Electrical Characteristics

- Absolute maximum rating

Rating	Min	Typ	Max	Unit	Notes
Storage Temperature	-40	-	125	°C	
VDD	-0.3	-	4.1	V	
Other Digital Terminals	-0.3	-	$V_{DD5}+0.3 \leq 4.1$	V	
Voltage on ADC input	-0.3	-	V _{DD5}	V	Voltage scaling enabled
	-0.3	-	1.49	V	Voltage scaling disabled, internal reference
	-0.3	-	V _{DD5} /2.9	V	Voltage scaling disabled, V _{DD5} as reference
RF pin	-	-	5	dBm	

- Recommended operating conditions

Rating	Min	Typ	Max	Unit
Operating Temperature	-40	-	105	°C
VDD	1.8	3.3	3.8	V

Pinout

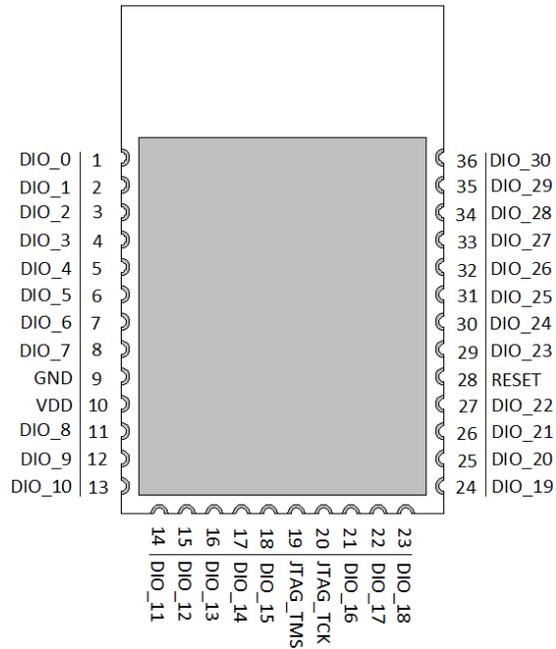


Fig. 2: The pinout of BDE-BLEM205-IN (TOP VIEW)

Table 1: Pin definitions of BDE-BLEM205-IN

Pin Number	Pin Name	Definitions
1	DIO_0	GPIO, Sensor Controller
2	DIO_1	GPIO, Sensor Controller
3	DIO_2	GPIO, Sensor Controller
4	DIO_3	GPIO, Sensor Controller
5	DIO_4	GPIO, Sensor Controller
6	DIO_5	GPIO, Sensor Controller, high-drive capability
7	DIO_6	GPIO, Sensor Controller, high-drive capability
8	DIO_7	GPIO, Sensor Controller, high-drive capability
9	GND	Power Ground
10	VDD	Power Supply
11	DIO_8	GPIO
12	DIO_9	GPIO
13	DIO_10	GPIO
14	DIO_11	GPIO
15	DIO_12	GPIO
16	DIO_13	GPIO
17	DIO_14	GPIO
18	DIO_15	GPIO
19	JTAG_TMS	JTAG TMS, high-drive capability
20	JTAG_TCK	JTAG TCK
21	DIO_16	GPIO, JTAG_TDO, high-drive capability

22	DIO_17	GPIO, JTAG_TDI, high-drive capability
23	DIO_18	GPIO
24	DIO_19	GPIO
25	DIO_20	GPIO
26	DIO_21	GPIO
27	DIO_22	GPIO
28	RESET	Reset, active-low
29	DIO_23	GPIO, Sensor Controller, Analog
30	DIO_24	GPIO, Sensor Controller, Analog
31	DIO_25	GPIO, Sensor Controller, Analog
32	DIO_26	GPIO, Sensor Controller, Analog
33	DIO_27	GPIO, Sensor Controller, Analog
34	DIO_28	GPIO, Sensor Controller, Analog
35	DIO_29	GPIO, Sensor Controller, Analog
36	DIO_30	GPIO, Sensor Controller, Analog

Overall Dimensions

Fig. 3 shows the overall dimensions of BDE-BLEM205-IN. The module measures 22.95mm long by 15mm wide by 2.1mm high with the shield.

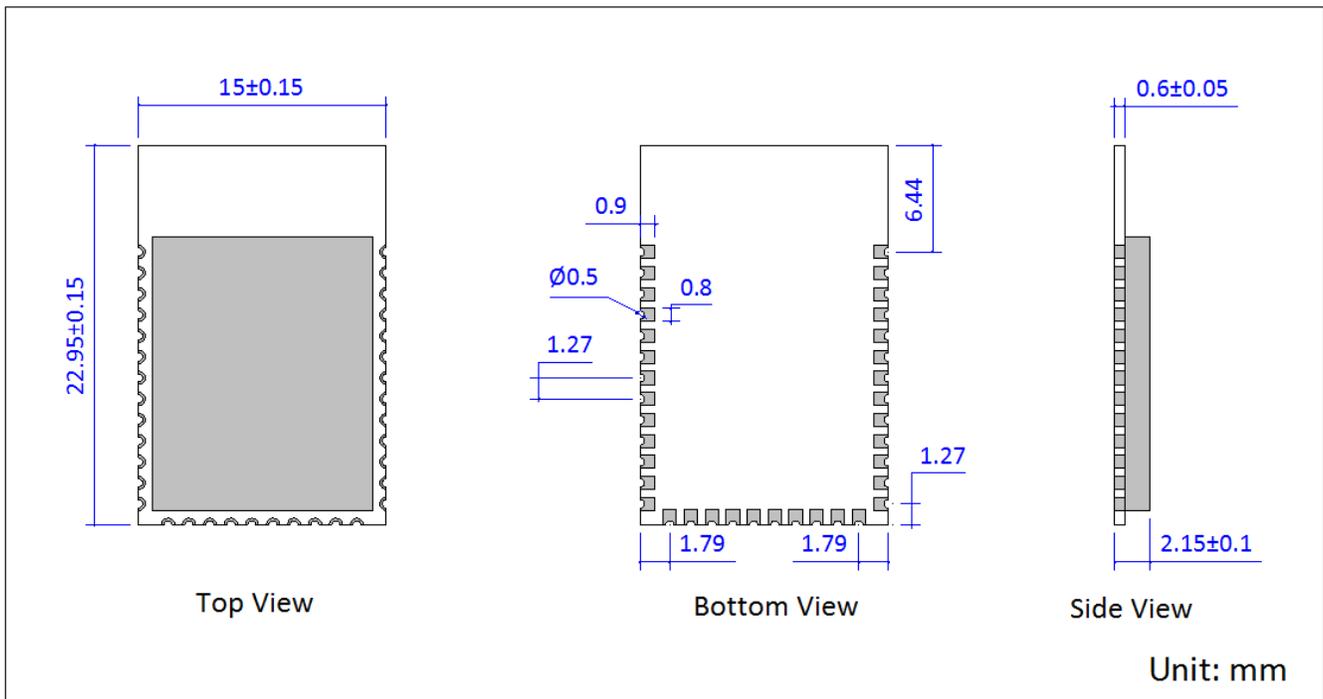


Fig. 3: Overall Dimensions of BDE-BLEM205-IN

Module Location

In order to get a fine performance when integrate the module to your product, it is advised to use the recommended module location to the respective PCB.

■ Location in X-Y plane

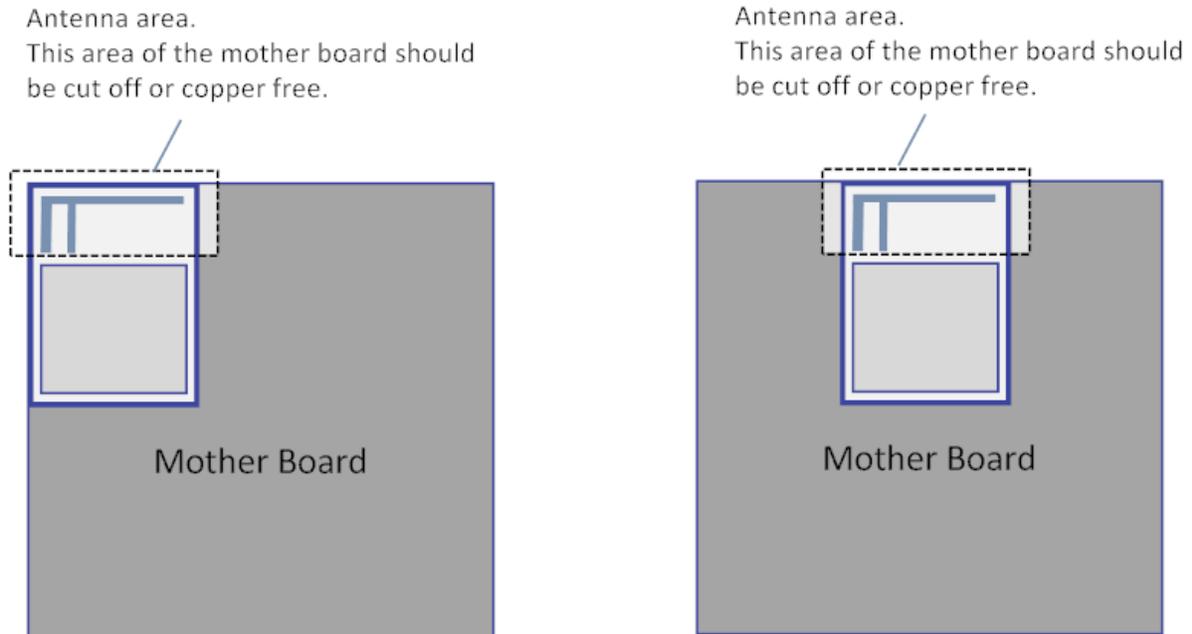


Fig. 4: Recommended location in X-Y plane

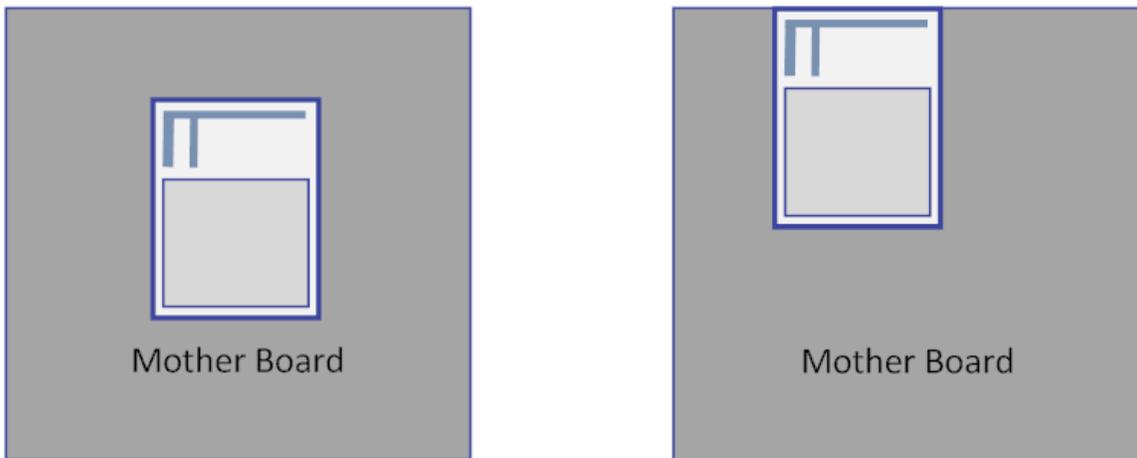


Fig. 5: Not recommended location in X-Y plane

■ Location in Z plane

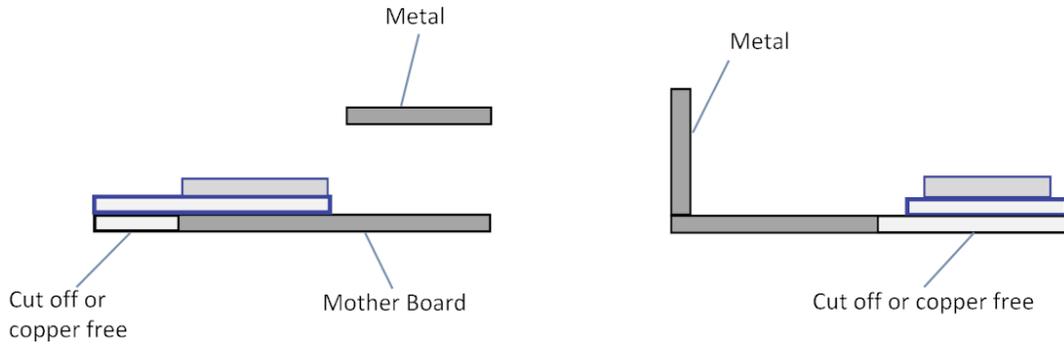


Fig. 6: Recommended location in Z plane

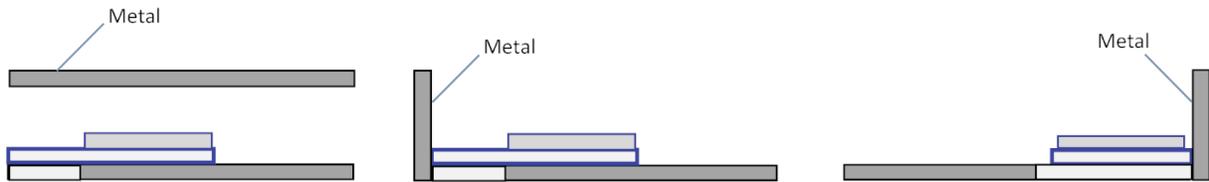


Fig. 7: Not recommended location in Z plane

Typical Solder Reflow Profile

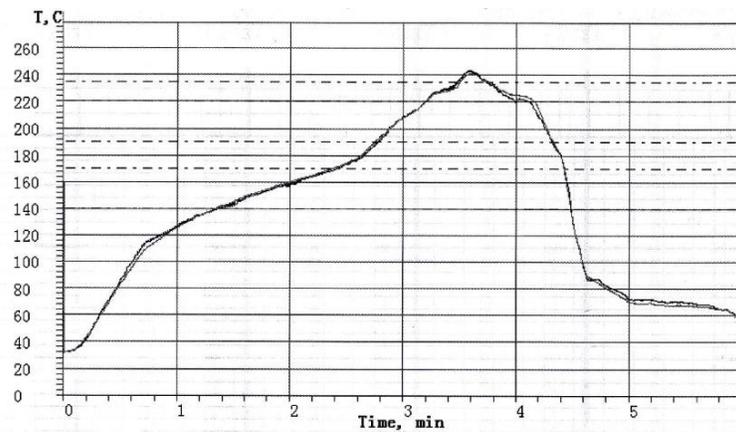


Fig. 8: Typical Solder Reflow Profile

Package Information



Fig. 9: Package

Contacts

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